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RoHS³

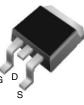
COMPLIANT

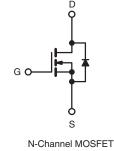
HALOGEN FREE

Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	250					
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	1.1				
Q _g (Max.) (nC)	14					
Q _{gs} (nC)	2.7					
Q _{gd} (nC)	7.8					
Configuration	Single					

D²PAK (TO-263)





FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK (TO-263) is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION	
Package	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHF624S-GE3
Lead (Pb)-free	IRF624SPbF
	SiHF624S-E3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unless otherwi	se noted)			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V _{DS}	250	V		
Gate-Source Voltage	V _{GS}	± 20	v		
Continuous Drain Current	V_{GS} at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$	۱ _D	4.4		
Continuous Drain Current	V_{GS} at 10 V $T_C = 100 \text{ °C}$		2.8	А	
Pulsed Drain Current ^a		I _{DM}	14	1	
Linear Derating Factor		0.40	W/°C		
Linear Derating Factor (PCB Mount) ^e		0.025	VV/ C		
Single Pulse Avalanche Energy ^b		E _{AS}	100	mJ	
Repetitive Avalanche Current ^a		I _{AR}	4.4	A	
Repetitive Avalanche Energy ^a		E _{AR}	5.0	mJ	
Maximum Power Dissipation	D	50	w		
Maximum Power Dissipation (PCB Mount)e	P _D	3.1	vv		
Peak Diode Recovery dV/dt ^c	dV/dt	4.8	V/ns		
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature)	for 10 s	Ŭ Ŭ	300 ^d		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 8.3 mH, $R_g = 25 \Omega$, $I_{AS} = 4.4 \text{ A}$ (see fig. 12). c. $I_{SD} \le 4.4 \text{ A}$, dl/dt $\le 90 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$.

1.6 mm from case. d.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATINGS								
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT			
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	40				
Maximum Junction-to-Ambient	R _{thJA}	-	-	62	°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	2.5				

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	_S = 0, I _D = 250 μA	250	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, $I_D = 1 \text{ mA}$			-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} :	2.0	-	4.0	V	
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20 V$			± 100	nA
Zara Cata Valtaga Drain Current		V _{DS} :	$V_{DS} = 250 \text{ V}, V_{GS} = 0 \text{ V}$		-	25	
Zero Gate voltage Drain Current	Gate Voltage Drain Current I_{DSS} $V_{DS} = 200V$, $V_{GS} = 0$ V, $T_J = 125$ °C		/, V _{GS} = 0 V, T _J = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.6 A ^b	-	-	1.1	Ω
Forward Transconductance	9 fs	V _{DS}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 2.6 \text{ A}^{b}$		-	-	S
Dynamic							
Input Capacitance	C _{iss}		V _{GS} = 0 V,	-	260	-	
Output Capacitance	Coss		$V_{DS} = 25 V,$	-	77	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	15	-	
Total Gate Charge	Qg			-	-	14	nC
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 4.4 A, V _{DS} = 200 V see fig. 6 and 13 ^b	-	-	2.7	
Gate-Drain Charge	Q _{gd}			-	-	7.8	
Turn-On Delay Time	t _{d(on)}			-	7.0	-	
Rise Time	t _r	V _{DD} :	= 125 V, I _D = 4.4 A	-	13	-	ns
Turn-Off Delay Time	t _{d(off)}	R _g =	= 18 Ω, R _D = 28 Ω see fig. 10 ^b	-	20	-	
Fall Time	t _f		See lig. 10	-	12	-	1
Internal Drain Inductance	L _D		Between lead, 6 mm (0.25") from		4.5	-	
Internal Source Inductance	L _S	package and die contact	-	7.5	-	- nH	
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	MOSFET symbol showing the integral reverse p - n junction diode		-	4.4	
Pulsed Diode Forward Current ^a	I _{SM}	0			-	14	- A
Body Diode Voltage	V _{SD}	T _J = 25 °C	C, $I_{S} = 4.4 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	-	-	1.8	V
Body Diode Reverse Recovery Time	t _{rr}	T.=	25 °C, I _F = 4.4 A,	-	200	400	ns
Body Diode Reverse Recovery Charge	Q _{rr}		$1/dt = 100 \text{ A}/\mu \text{s}^{b}$	-	0.93	1.9	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated k	vleand	<u>п</u>

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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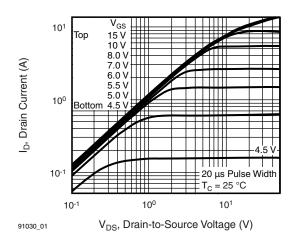


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

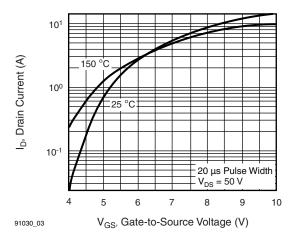


Fig. 3 - Typical Transfer Characteristics

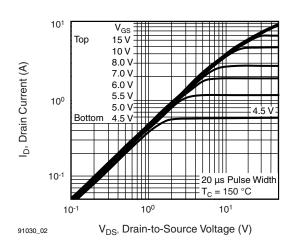


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^\circ C$

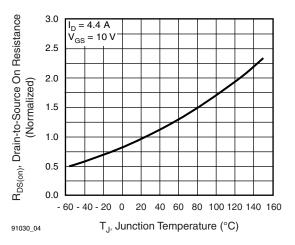
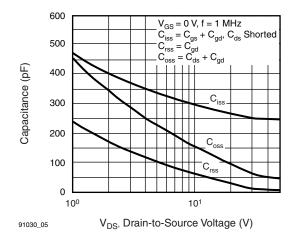


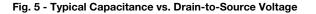
Fig. 4 - Normalized On-Resistance vs. Temperature

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 $(V) = 10^{10} \\ (O) = 10^{10$

Fig. 7 - Typical Source-Drain Diode Forward Voltage

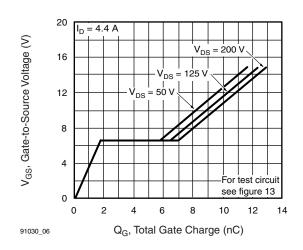


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

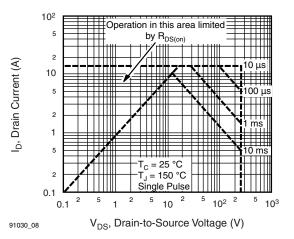


Fig. 8 - Maximum Safe Operating Area

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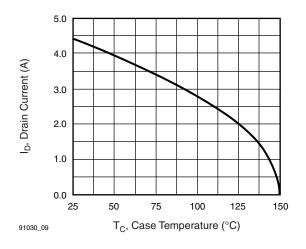


Fig. 9 - Maximum Drain Current vs. Case Temperature

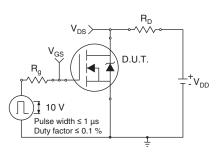


Fig. 10a - Switching Time Test Circuit

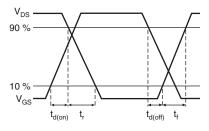


Fig. 10b - Switching Time Waveforms

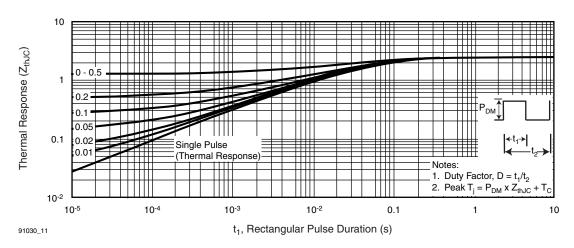


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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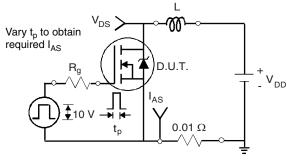


Fig. 12a - Unclamped Inductive Test Circuit

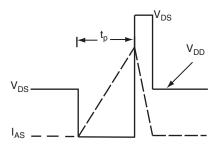


Fig. 12b - Unclamped Inductive Waveforms

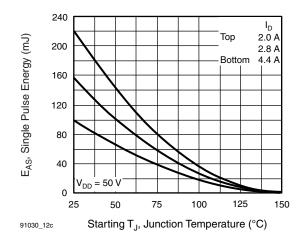


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

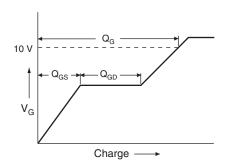


Fig. 13a - Basic Gate Charge Waveform

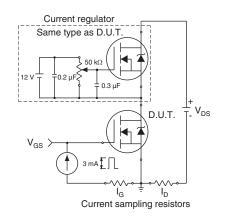
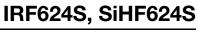


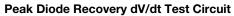
Fig. 13b - Gate Charge Test Circuit

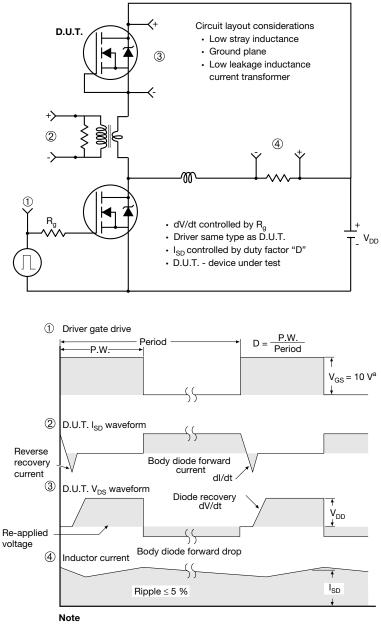
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a. V_{GS} = 5 V for logic level devices

Fig. 14 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?91030</u>.

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H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

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Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	Y 2 x b2 2 x b ⊕ 0.010 @ A(■ ating 5 b1, b b1, b b1, b c) c) c) c) c) c) c) c) c) c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{5} \\ c_{7} \\$	a - 1		Ū.	1 <u>4</u>		
	MILLIN	IETERS	INCHES				MILLIN	METERS INC		CHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-	
				0.010		-		10.07	0.000	0.420	
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.120	
A1 b	0.00 0.51	0.25 0.99	0.000	0.010		E1	9.65 6.22	- 10.67	0.380	-	
							6.22	- 10.67 - BSC	0.245	- BSC	
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-	
b b1	0.51 0.51	0.99 0.89	0.020 0.020	0.039 0.035		E1 e	6.22 2.54	- BSC	0.245	-) BSC	
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.020 0.045	0.039 0.035 0.070		E1 e H	6.22 2.54 14.61	- BSC 15.88	0.245 0.100 0.575	-) BSC 0.625	
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.020 0.045 0.045	0.039 0.035 0.070 0.068		E1 e H L	6.22 2.54 14.61 1.78	- BSC 15.88 2.79	0.245 0.100 0.575 0.070	- 0 BSC 0.625 0.110	
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.020 0.045 0.045 0.015	0.039 0.035 0.070 0.068 0.029		E1 e H L L1	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066	
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.020 0.045 0.045 0.015 0.015	0.039 0.035 0.070 0.068 0.029 0.023		E1 e H L L1 L2	6.22 2.54 14.61 1.78 - -	- BSC 15.88 2.79 1.65 1.78	0.245 0.100 0.575 0.070 - -	- 0 BSC 0.625 0.110 0.066 0.070	

А

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



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